



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

David R. Hembree

**Serial No.:** 10/624,332

**Filed:** July 22, 2003

**For:** CHIP ON BOARD AND HEAT SINK  
ATTACHMENT METHODS

**Confirmation No.:** 6977

**Examiner:** A. Roman

**Group Art Unit:** 2812

**Attorney Docket No.:** 2269-3592.8US  
(97-0321.08/US)

**Notice of Allowance Mailed:**

November 18, 2004

**NOTICE OF EXPRESS MAILING**

Express Mail Mailing Label Number: EL994823691US

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Person making Deposit: Steve Wong

**AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

**Amendments to the Specification** begin on page 3 of this paper.

**Amendments to the Abstract** appear on page 8 of this paper.

A **Listing of the Claims** begins on page 9 of this paper.

**Amendments to the Drawings** appear on page 11 of this paper and include both attached replacement sheets and annotated sheets showing changes.

**Remarks** begin on page 12 of this paper.

An **Appendix** including amended drawing figures is attached following page 12 of this paper.